



800mA Low Dropout Regulator SCSI-II Active Terminator

(Preliminary Information) - Production 1Q '97

FEATURES

- Guaranteed 800mA Output
- Three Terminal Adjustable Or Fixed 2.85V, 3V, 3.3V, 5V, 10V & 12V
- Very Low Quiescent Current
- Low Dropout Voltage Of 1.2 Volts At Full Load
- Extremely Tight Load And Line Regulation
- Very Low Temperature Coefficient
- Fixed 2.85V Device For SCSI-II Active Terminator
- · Logic-Controlled Electronic Shutdown
- Internal Overcurrent Limiting & Thermal Overload Protection
- Surface Mount Package SOT-223, TO-263, & TO-220

APPLICATIONS

- SCSI-II Active Terminator
- Portable/ Palm Top / Notebook Computers
- Battery Chargers
- Disk Drives
- Portable Consumer Equipment
- Portable Instrumentation
- SMPS Post-Regulator

PRODUCT DESCRIPTION

The ALPHA Semiconductor AS1117 is a low power positive voltage regulator designed to meet 800mA output current and comply with SCSI-II specifications with a fixed output voltage of 2.85V. This device is an excellent choice for use in battery-powered applications, as active terminators for the SCSI bus, and portable computers. The AS1117 features very low quiescent current and very low dropout voltage of 1.2V at a full load and lower as output current decreases. This product is available as an adjustable or fixed 2.85V, 3V, 3.3V, and 5V output voltages.

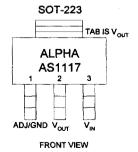
The AS1117 is offered in a 3-pin surface mount package SOT-223 & TO-263. The output capacitor of 10μF or larger is needed for output stability of AS1117 as required by most of the other regulator circuits. Use of ALPHA Semiconductor's design, processing and testing techniques make our AS1117 superior over similar products.

ORDERING INFORMATION

TO-220 3-PIN	SOT-223 3-PIN	Description	Oper. Temp. Range
AS1117U	AS1117M	Adjustable	IND.
AS1117U-X	AS1117M-X	X= output voltage	IND.

IND: temp: -40C to +85C

Pin Connections



ABSOLUTE MAXIMUM RATINGS

Power Dissipation	Internally Limited	Input Supply Voltage20V to +20V
Lead Temp. (Soldering, 5 Seconds)	260°C	ESD Rating2KV Min
Storage Temperature Range	65° to +150°C	
Operating Junction Temperature Range		
AS1117	40C° to +125°C	
Input Voltage	2.5V to 6V	

ELECTRICAL CHARACTERISTICS at $V_{IN} = V_{OUT} + 1$, Ta = 25°C, $CL = 3.3 \mu f$, unless otherwise specified. Limits in Boldface apply over the full operating temperature range.

			AS1117A		Units
Parameter	Conditions	Тур	Min Max		
Output Voltage	I _{OUT} =10mA, V _{IN} =4.85V	2.85	2.82	2.88	V
-	$0 \le I_{OUT} \le 800 \text{mA}, 4.25 \le V_{IN} \le 10 \text{V}$	2.85	2.79	2.91	
	0≤I _{OUT} ≤500mA, V _{IN} =4.05V	2.85	2.79	2.91	1 .
	$I_{OUT} = 10 \text{mA}, V_{IN} = 5.00 \text{V}$	3.00	2.97	3.03	
	0≤I _{OUT} ≤800mA, 4.50≤V _{IN} ≤10V	3.00	2.94	3.06	
	$I_{OUT}=10$ mA, $V_{IN}=5.30$ V			`	
	0≤I _{OUT} ≤800mA, 4.80≤V _{IN} ≤10V	3.30	3.27	3.33	I.
		3.30	3.24	3.36	
	I _{OUT} =10mA, V _{IN} =7.00V	5.00	4.95	5.05	*
	$0 \le I_{OUT} \le 800 \text{mA}, 6.50 \le V_{IN} \le 12 \text{V}$	5.00	4.90	5.10	
Output Voltage				0.05	%
Temperature Stability	(Note 1)		I		
Line Regulation	$4.25V \le V_{in} \le 10V, V_{OUT} = 2.85, I_{OUT} = 0$	1.00		6.00	mV
•	$4.50V \le V_{in} \le 12V, V_{out} = 3.00, I_{out} = 0$	1.00	1	7.00	
	$4.80V \le V_{in} \le 12V, V_{out} = 3.30, I_{out} = 0$	1.00		7.00	
	$6.50V \le V_{in} \le 15V, V_{out} = 5.00, I_{out} = 0$	1.00		10.00	
Load Regulation	0≤I _{OUT} ≤800mA, V _{IN} =4.25V, V _{OUT} =2.85	1.00		10.00	mV
	$0 \le I_{OUT} \le 800 \text{mA}, V_{IN} = 4.50 \text{V}, V_{OUT} = 3.00$	1.00		12.00	
	$0 \le I_{OUT} \le 800 \text{mA}, V_{IN} = 4.80 \text{V}, V_{OUT} = 3.30$	1.00		12.00	
	$0 \le I_{OUT} \le 800 \text{mA}, V_{IN} = 6.50 \text{V}, V_{OUT} = 5.00$	1.00		15.00	
Dropout Voltage	$I_{1} = 100 \text{mA}$	1.00		1.10	V
(Note 2)	$I_L = 500 \text{mA}$	1.05		1.15	
	$I_{L} = 800 \text{mA}$	1.10		1.20	
Quiescent Current	4.25V ≤V _{in} ≤6.5V	5.00		10.00	mA
Current Limit	(V _N -V _{OUT})=5V	800	950	1200	mA
Thermal Regulation	25°°C,30mS Pulse	0.01		0.1	%/W
Ripple Rejection	$f_{RIPPLE}=120Hz$, $(V_{in}-V_{OUT})=3V$, $V_{RIPPLE}=1V_{p-p}$	60		75	dB
Long Term Stability	125°C, 1000Hrs		1	0.03	%
RMS Output Noise	% of V _{out} , 10Hz≤f≤10kHz			0.003	%
Thermal Resistance	Junction to case, at tab			15	°C/W°

Note 1: Output temperature coefficient is defined as the worst case voltage change divided by the total temperature range

Note 2: Dropout voltage is defined as the input to output differential at which the output voltage drops 100mV below its nominal value measured at 1V differential at very low values of programmed output voltage, the minimum input supply voltage of 2V (2.3V over temperature) must be taken into account.

Note 3: Thermal regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effect.

APPLICATION NOTES EXTERNAL CAPACITOR

To ensure the stability of the AS1117 an output capacitor of at least $10\mu F$ (tantalum)or $50\mu F$ (aluminum) is required. The value may change based on the application requirements on the output load or temperature range. The capacitor equivalent series resistance (ESR) will effect the AS1117 stability. The value of ESR can vary from the type of capacitor used in the applications. The recommended value for ESR is 0.5Ω . The output capacitance could increase in size to above the minimum value. The larger value of output capacitance as high as $100\mu F$ can improve the load transient response.

SOLDERING METHODS

The AS1117 SOT-223 package is designed to be compatible with infrared reflow or vapor-phase reflow soldering techniques. During soldering the non-active or mildly active fluxes may be used. The AS1117 die is attached to the heatsink lead which exits opposite the input, output, and ground pins.

Hand soldering and wave soldering should be avoided since these methods can cause damage to the device with excessive thermal gradients on the package. The SOT-223 recommended soldering method are as follows: vapor phase reflow and infrared reflow with the component preheated to within 65°C of the soldering temperature range.

THERMAL CHARACTERISTICS

The thermal resistance of AS1117 is °C/W from junction to tab and 31 °C/W from tab to ambient for a total of 46 °C/W from junction to ambient. The AS1117 features the internal thermal limiting to protect the device during overload conditions. Special care needs to be taken during continuos load conditions the maximum junction temperature does not exceed 125 °C.

Taking the FR-4 printed circuit board and 1/16 thick with 1 ounce copper foil as an experiment (fig.1 & fig.2), the PCB material is effective at transmitting heat with the tab attached to the pad area and a ground plane layer on the backside of the substrate. Refer to table 1 for the results of the experiment.

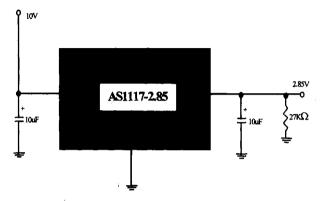
The thermal interaction from other components in the application can effect the thermal resistance of the AS1117. The actual thermal resistance can be determined with experimentation. AS1117 power dissipation is calculated as follows:

$$P_D = (V_D - V_{OUT})(I_{OUT})$$

Maximum Junction Temperature range:

 $T_J = T_{ambient}$ (max) + P_D (thermal resistance(Junction-to-ambient)

Maximum Junction temperature must not exceed the 125°C.



 $P_0 = (10V - 2.85)(105mA) = (7.15)(105mA) = 750mW$

Fig. 1. Circuit Layout, Thermal Experiments.

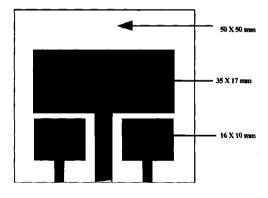


Fig. 2. Substrate Layout for SOT-223

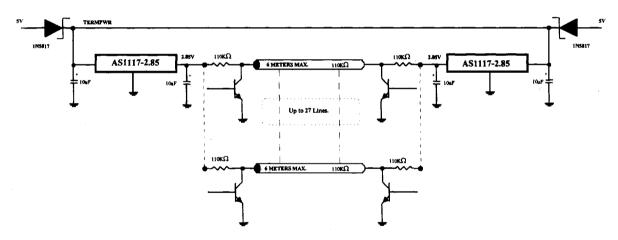
Table 1.

TOTAL PC BOARD AREA	TOPDIDE COPPER AREA	BACKSIDE COPPER AREA	THERMAL RESISTANCE JUNCTION TO AMBIENT
2500mm	2500mm	2500mm	46°C/W°
2500mm	1250mm	2500mm	47°C/W°
2500mm	950mm	2500mm	49°C/W°
2500mm	2500mm	0	51°C/W°
2500mm	1800mm	0	1
1600mm	600mm	1600mm	53°C/W°
2500mm	1250mm	0	55°C/W°
2500mm	915mm	0	58°C/W°
1600mm	600mm	0	59°C/W°
900mm	240mm	900mm	67°C/W°
900mm	240mm	0	72°C/W°
			85°C/W°

ACTIVE VS PASSIVE TERMINATION

The improvement in noise immunity and low quiescent power of the terminator of less than 1W is the key advantage of active termination compared to passive termination. The AS1117 significantly improves the noise level and signals on the bus by the terminating point due to variations in voltage at the termination point due to variation in the V_{term} power line. Another advantage of active termination is the improvement

in the impedance matching. The low impedance of the device makes the termination resistance more near the impedance of the cable. This improvement increase the data rate by 10 times from 1mbyte/s to 10mbyte/s. The AS1117 increases the protection and the reliability of the application since it features internal current limiting, over voltage protection, and thermal protection.



Active Termination Configuration